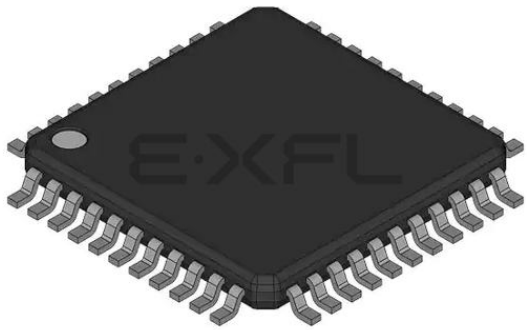
Atmel - AT89C51RD2-RLTUM Datasheet



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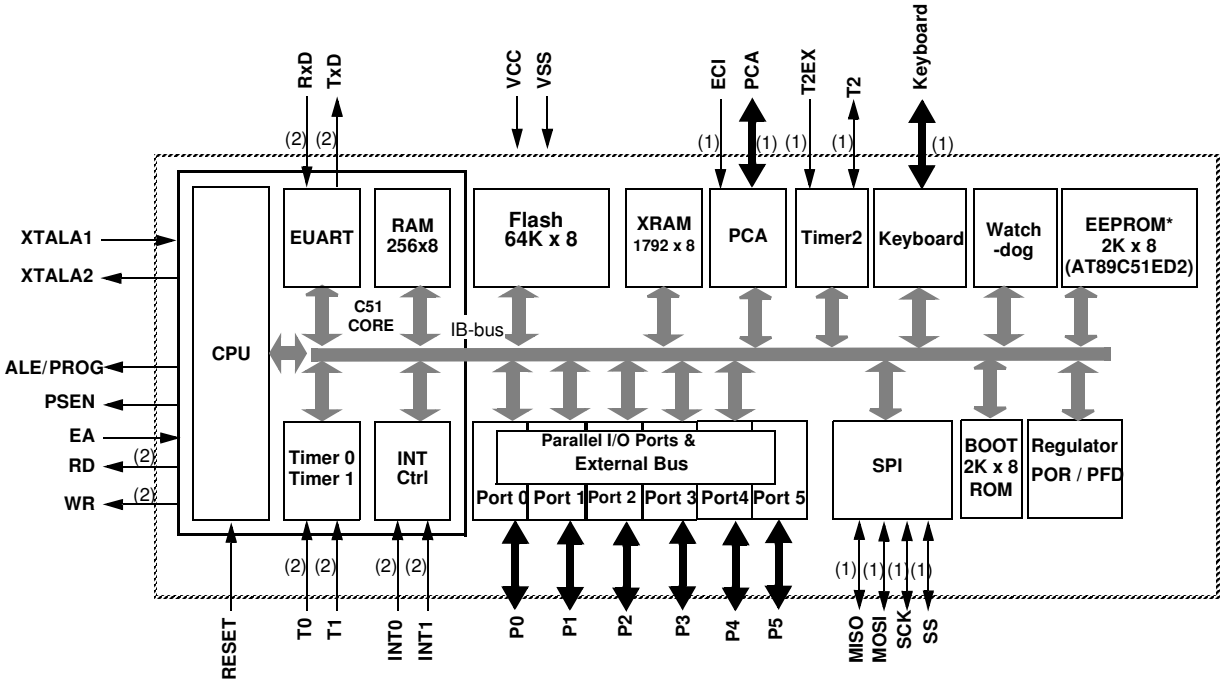
"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "Embedded - Microcontrollers"

Details	
Product Status	Active
Core Processor	80C51
Core Size	8-Bit
Speed	60MHz
Connectivity	SPI, UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	34
Program Memory Size	64KB (64K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	2.7V ~ 5.5V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-LQFP
Supplier Device Package	44-VQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/atmel/at89c51rd2-rltum

2. Block Diagram

Figure 2-1. Block Diagram



(1): Alternate function of Port 1

(2): Alternate function of Port 3

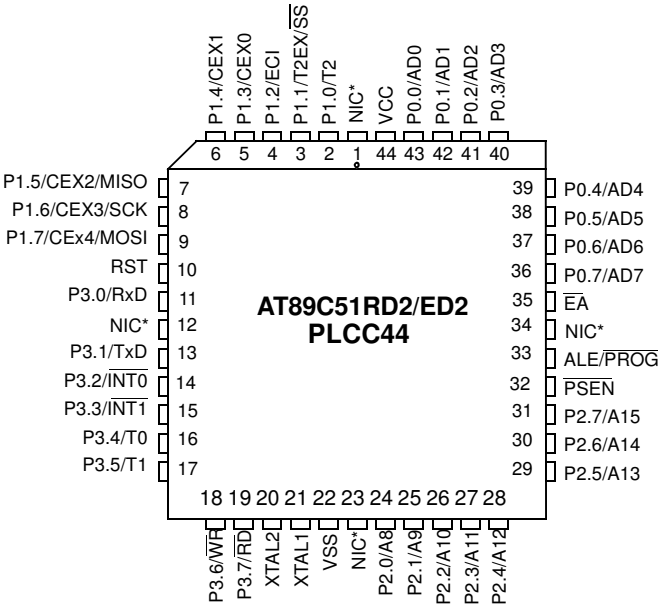
Table 3-11. SFR Mapping

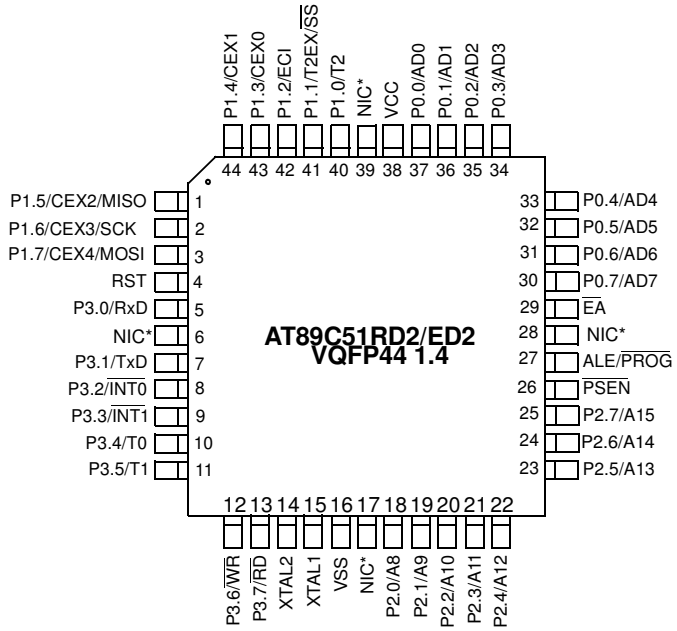
A0h	P2 1111 1111		AUXR1 0XXX X0X0				WDTRST XXXX XXXX	WDTPRG XXXX X000	A7h
98h	SCON 0000 0000	SBUF XXXX XXXX	BRL 0000 0000	BDRCON XXX0 0000	KBLS 0000 0000	KBE 0000 0000	KBF 0000 0000		9Fh
90h	P1 1111 1111							CKRL 1111 1111	97h
88h	TCON 0000 0000	TMOD 0000 0000	TL0 0000 0000	TL1 0000 0000	TH0 0000 0000	TH1 0000 0000	AUXR 0X00 1000	CKCON0 0000 0000	8Fh
80h	P0 1111 1111	SP 0000 0111	DPL 0000 0000	DPH 0000 0000				PCON 00X1 0000	87h
	0/8	1/9	2/A	3/B	4/C	5/D	6/E	7/F	

reserved

4. Pin Configurations

Figure 4-1. Pin Configurations





5. Port Types

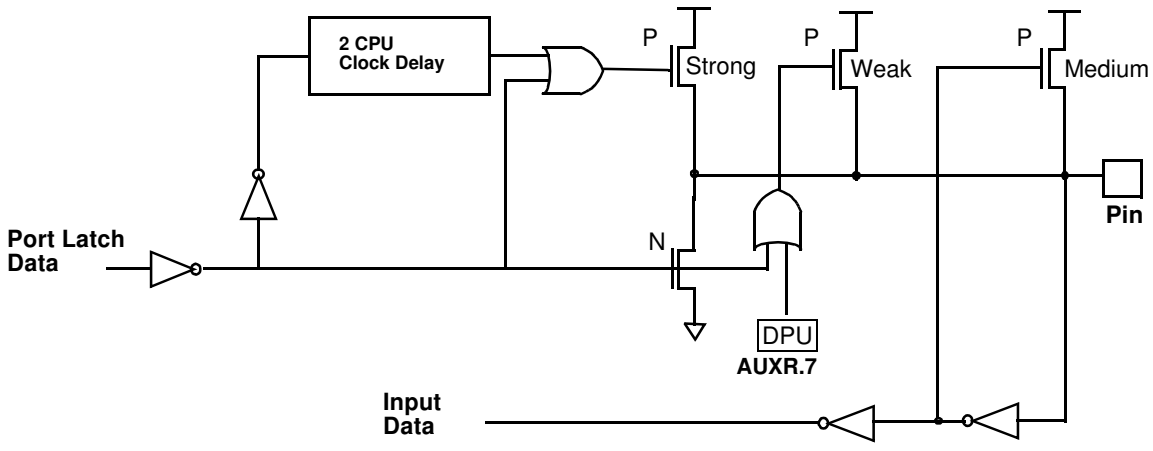
AT89C51RD2/ED2 I/O ports (P1, P2, P3, P4, P5) implement the quasi-bidirectional output that is common on the 80C51 and most of its derivatives. This output type can be used as both an input and output without the need to reconfigure the port. This is possible because when the port outputs a logic high, it is weakly driven, allowing an external device to pull the pin low. When the pin is pulled low, it is driven strongly and able to sink a fairly large current. These features are somewhat similar to an open drain output except that there are three pull-up transistors in the quasi-bidirectional output that serve different purposes. One of these pull-ups, called the "weak" pull-up, is turned on whenever the port latch for the pin contains a logic 1. The weak pull-up sources a very small current that will pull the pin high if it is left floating. A second pull-up, called the "medium" pull-up, is turned on when the port latch for the pin contains a logic 1 and the pin itself is also at a logic 1 level. This pull-up provides the primary source current for a quasi-bidirectional pin that is outputting a 1. If a pin that has a logic 1 on it is pulled low by an external device, the medium pull-up turns off, and only the weak pull-up remains on. In order to pull the pin low under these conditions, the external device has to sink enough current to overpower the medium pull-up and take the voltage on the port pin below its input threshold.

The third pull-up is referred to as the "strong" pull-up. This pull-up is used to speed up low-to-high transitions on a quasi-bidirectional port pin when the port latch changes from a logic 0 to a logic 1. When this occurs, the strong pull-up turns on for a brief time, two CPU clocks, in order to pull the port pin high quickly. Then it turns off again.

The DPU bit (bit 7 in AUXR register) allows to disable the permanent weak pull up of all ports when latch data is logical 0.

The quasi-bidirectional port configuration is shown in Figure 5-1.

Figure 5-1. Quasi-Bidirectional Output



7. Enhanced Features

In comparison to the original 80C52, the AT89C51RD2/ED2 implements some new features, which are:

- X2 option
- Dual Data Pointer
- Extended RAM
- Programmable Counter Array (PCA)
- Hardware Watchdog
- SPI interface
- 4-level interrupt priority system
- Power-off flag
- ONCE mode
- ALE disabling
- Some enhanced features are also located in the UART and the Timer 2

7.1 X2 Feature

The AT89C51RD2/ED2 core needs only 6 clock periods per machine cycle. This feature called ‘X2’ provides the following advantages:

- Divide frequency crystals by 2 (cheaper crystals) while keeping same CPU power.
- Save power consumption while keeping same CPU power (oscillator power saving).
- Save power consumption by dividing dynamically the operating frequency by 2 in operating and idle modes.
- Increase CPU power by 2 while keeping same crystal frequency.

In order to keep the original C51 compatibility, a divider by 2 is inserted between the XTAL1 signal and the main clock input of the core (phase generator). This divider may be disabled by software.

7.1.1 Description

The clock for the whole circuit and peripherals is first divided by two before being used by the CPU core and the peripherals.

This allows any cyclic ratio to be accepted on XTAL1 input. In X2 mode, as this divider is bypassed, the signals on XTAL1 must have a cyclic ratio between 40 to 60%.

Figure 7-1 shows the clock generation block diagram. X2 bit is validated on the rising edge of the XTAL1 ÷ 2 to avoid glitches when switching from X2 to STD mode. Figure 7-2 shows the switching mode waveforms.

Bit Number	Bit Mnemonic	Description
5	PCAX2	**Programmable Counter Array Clock** (This control bit is validated when the CPU clock X2 is set; when X2 is low, this bit has no effect). Cleared to select 6 clock periods per peripheral clock cycle. Set to select 12 clock periods per peripheral clock cycle.
4	SIX2	**Enhanced UART Clock (Mode 0 and 2)** (This control bit is validated when the CPU clock X2 is set; when X2 is low, this bit has no effect). Cleared to select 6 clock periods per peripheral clock cycle. Set to select 12 clock periods per peripheral clock cycle.
3	T2X2	**Timer2 Clock** (This control bit is validated when the CPU clock X2 is set; when X2 is low, this bit has no effect). Cleared to select 6 clock periods per peripheral clock cycle. Set to select 12 clock periods per peripheral clock cycle.
2	T1X2	**Timer1 Clock** (This control bit is validated when the CPU clock X2 is set; when X2 is low, this bit has no effect). Cleared to select 6 clock periods per peripheral clock cycle. Set to select 12 clock periods per peripheral clock cycle.
1	T0X2	Timer0 Clock (This control bit is validated when the CPU clock X2 is set; when X2 is low, this bit has no effect). Cleared to select 6 clock periods per peripheral clock cycle. Set to select 12 clock periods per peripheral clock cycle.
0	X2	**CPU Clock** Cleared to select 12 clock periods per machine cycle (STD mode) for CPU and all the peripherals. Set to select 6 clock periods per machine cycle (X2 mode) and to enable the individual peripherals'X2' bits. Programmed by hardware after Power-up regarding Hardware Security Byte (HSB), Default setting, X2 is cleared.

Reset Value = 0000 000'HSB. X2'b (See "Hardware Security Byte")
Not bit addressable

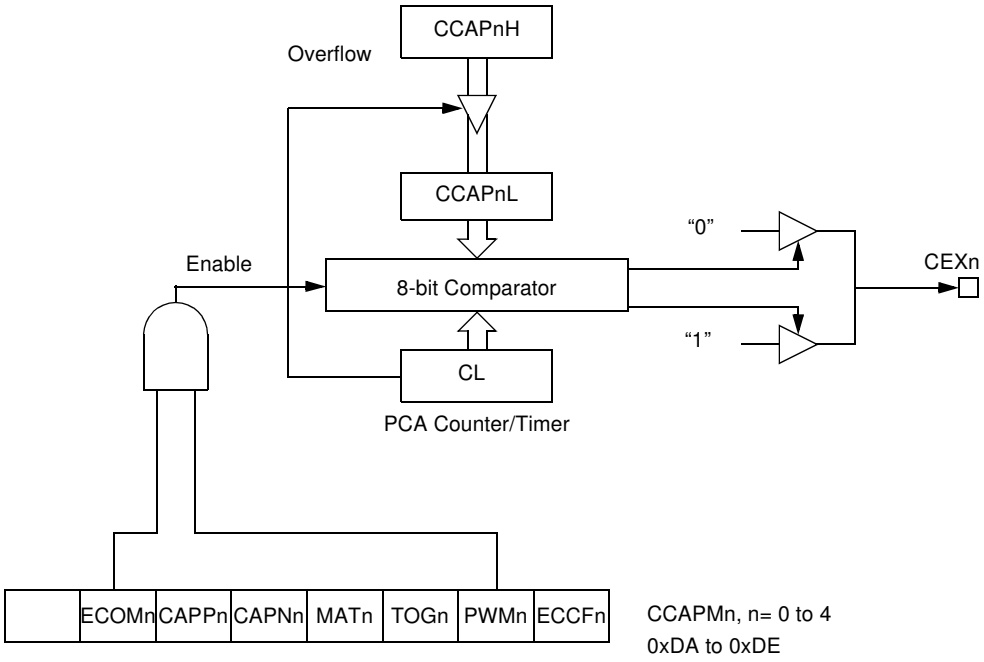
Table 7-2. CKCON1 Register

CKCON1 - Clock Control Register (AFh)

7	6	5	4	3	2	1	0
-	-	-	-	-	-	-	SPIX2

Bit Number	Bit Mnemonic	Description
7	-	Reserved
6	-	Reserved
5	-	Reserved
4	-	Reserved
3	-	Reserved

Figure 13-6. PCA PWM Mode



13.5 PCA Watchdog Timer

An on-board watchdog timer is available with the PCA to improve the reliability of the system without increasing chip count. Watchdog timers are useful for systems that are susceptible to noise, power glitches, or electrostatic discharge. Module 4 is the only PCA module that can be programmed as a watchdog. However, this module can still be used for other modes if the watchdog is not needed. Figure 13-4 shows a diagram of how the watchdog works. The user pre-loads a 16-bit value in the compare registers. Just like the other compare modes, this 16-bit value is compared to the PCA timer value. If a match is allowed to occur, an internal reset will be generated. This will not cause the RST pin to be driven high.

In order to hold off the reset, the user has three options:

1. Periodically change the compare value so it will never match the PCA timer.
2. Periodically change the PCA timer value so it will never match the compare values.
3. Disable the watchdog by clearing the WDTE bit before a match occurs and then re-enable it.

The first two options are more reliable because the watchdog timer is never disabled as in option #3. If the program counter ever goes astray, a match will eventually occur and cause an internal reset. The second option is also not recommended if other PCA modules are being used. Remember, the PCA timer is the time base for all modules; changing the time base for other modules would not be a good idea. Thus, in most applications the first solution is the best option.

This watchdog timer won't generate a reset out on the reset pin.

14.3 Registers

Table 14-1. SADEN Register

SADEN - Slave Address Mask Register (B9h)

7	6	5	4	3	2	1	0

Reset Value = 0000 0000b
Not bit addressable

Table 14-2. SADDR Register

SADDR - Slave Address Register (A9h)

7	6	5	4	3	2	1	0

Reset Value = 0000 0000b
Not bit addressable

14.4 Baud Rate Selection for UART for Mode 1 and 3

The Baud Rate Generator for transmit and receive clocks can be selected separately via the T2CON and BDRCON registers.

Figure 14-4. Baud Rate Selection

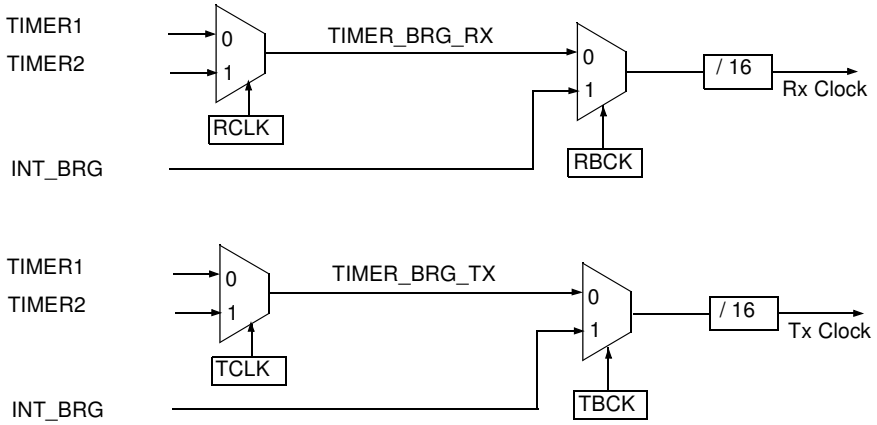


Table 14-4. SCON Register

SCON - Serial Control Register (98h)

7	6	5	4	3	2	1	0
FE/SM0	SM1	SM2	REN	TB8	RB8	TI	RI

Bit Number	Bit Mnemonic	Description
7	FE	**Framing Error bit (SMOD0=1)** Clear to reset the error state, not cleared by a valid stop bit. Set by hardware when an invalid stop bit is detected. SMOD0 must be set to enable access to the FE bit.
	SM0	**Serial port Mode bit 0** Refer to SM1 for serial port mode selection. SMOD0 must be cleared to enable access to the SM0 bit.
6	SM1	**Serial port Mode bit 1** SM0 SM1 Mode — Baud Rate 0 0 Shift Register — $F_{XTAL}/12$ (or $F_{XTAL}/6$ in mode X2) 0 1 8-bit UART — Variable 1 0 9-bit UART — $F_{XTAL}/64$ or $F_{XTAL}/32$ 1 1 9-bit UART — Variable
5	SM2	Serial port Mode 2 bit / Multiprocessor Communication Enable bit Clear to disable multiprocessor communication feature. Set to enable multiprocessor communication feature in mode 2 and 3, and eventually mode 1.This bit should be cleared in mode 0.
4	REN	**Reception Enable bit** Clear to disable serial reception. Set to enable serial reception.
3	TB8	Transmitter Bit 8 / Ninth bit to transmit in modes 2 and 3 Clear to transmit a logic 0 in the 9th bit. Set to transmit a logic 1 in the 9th bit.
2	RB8	**Receiver Bit 8 / Ninth bit received in modes 2 and 3** Cleared by hardware if 9th bit received is a logic 0. Set by hardware if 9th bit received is a logic 1. In mode 1, if SM2 = 0, RB8 is the received stop bit. In mode 0 RB8 is not used.
1	TI	**Transmit Interrupt flag** Clear to acknowledge interrupt. Set by hardware at the end of the 8th bit time in mode 0 or at the beginning of the stop bit in the other modes.
0	RI	**Receive Interrupt flag** Clear to acknowledge interrupt. Set by hardware at the end of the 8th bit time in mode 0, see Figure 14-2. and Figure 14-3. in the other modes.

Reset Value = 0000 0000b

Bit addressable

Table 14-9. SBUF Register

SBUF - Serial Buffer Register for UART (99h)

7	6	5	4	3	2	1	0

Reset Value = XXXX XXXXb

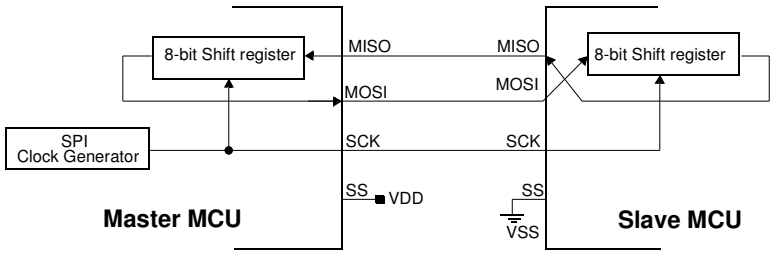
Table 14-10. BRL Register

BRL - Baud Rate Reload Register for the internal baud rate generator, UART (9Ah)

7	6	5	4	3	2	1	0

Reset Value = 0000 0000b

Figure 16-3. Full-Duplex Master-Slave Interconnection



16.3.1.1 Master Mode

The SPI operates in Master mode when the Master bit, MSTR (1), in the SPCON register is set. Only one Master SPI device can initiate transmissions. Software begins the transmission from a Master SPI Module by writing to the Serial Peripheral Data Register (SPDAT). If the shift register is empty, the Byte is immediately transferred to the shift register. The Byte begins shifting out on MOSI pin under the control of the serial clock, SCK. Simultaneously, another Byte shifts in from the Slave on the Master's MISO pin. The transmission ends when the Serial Peripheral transfer data flag, SPIF, in SPSTA becomes set. At the same time that SPIF becomes set, the received Byte from the Slave is transferred to the receive data register in SPDAT. Software clears SPIF by reading the Serial Peripheral Status register (SPSTA) with the SPIF bit set, and then reading the SPDAT.

16.3.1.2 Slave Mode

The SPI operates in Slave mode when the Master bit, MSTR (2), in the SPCON register is cleared. Before a data transmission occurs, the Slave Select pin, $\overline{SS}$, of the Slave device must be set to '0'. $\overline{SS}$ must remain low until the transmission is complete.

In a Slave SPI Module, data enters the shift register under the control of the SCK from the Master SPI Module. After a Byte enters the shift register, it is immediately transferred to the receive data register in SPDAT, and the SPIF bit is set. To prevent an overflow condition, Slave software must then read the SPDAT before another Byte enters the shift register (3). A Slave SPI must complete the write to the SPDAT (shift register) at least one bus cycle before the Master SPI starts a transmission. If the write to the data register is late, the SPI transmits the data already in the shift register from the previous transmission. The maximum SCK frequency allowed in slave mode is $F_{CLK\ PERIPH}/4$.

16.3.2 Transmission Formats

Software can select any of four combinations of serial clock (SCK) phase and polarity using two bits in the SPCON: the Clock Polarity (CPOL (4)) and the Clock Phase (CPHA[4]). CPOL defines the default SCK line level in idle state. It has no significant effect on the transmission format. CPHA defines the edges on which the input data are sampled and the edges on which the output data are shifted (Figure 16-4 and Figure 16-5). The clock phase and polarity should be identical for the Master SPI device and the communicating Slave device.

1. The SPI Module should be configured as a Master before it is enabled (SPEN set). Also, the Master SPI should be configured before the Slave SPI.
2. The SPI Module should be configured as a Slave before it is enabled (SPEN set).
3. The maximum frequency of the SCK for an SPI configured as a Slave is the bus clock speed.
4. Before writing to the CPOL and CPHA bits, the SPI should be disabled (SPEN = '0').

Table 17-7. IPL1 Register

IPL1 - Interrupt Priority Register (B2h)

7	6	5	4	3	2	1	0
-	-	-	-	-	SPIL	TWIL	KBDL

Bit Number	Bit Mnemonic	Description
7	-	**Reserved** The value read from this bit is indeterminate. Do not set this bit.
6	-	**Reserved** The value read from this bit is indeterminate. Do not set this bit.
5	-	**Reserved** The value read from this bit is indeterminate. Do not set this bit.
4	-	**Reserved** The value read from this bit is indeterminate. Do not set this bit.
3	-	**Reserved** The value read from this bit is indeterminate. Do not set this bit.
2	SPIL	**SPI interrupt Priority bit** Refer to SPIH for priority level.
1	-	**Reserved** The value read from this bit is indeterminate. Do not set this bit.
0	KBDL	**Keyboard interrupt Priority bit** Refer to KBDH for priority level.

Reset Value = XXXX X000b

Bit addressable

Table 17-8. IPH1 Register

IPH1 - Interrupt Priority High Register (B3h)

7	6	5	4	3	2	1	0
-	-	-	-	-	SPIH	-	KBDH

Bit Number	Bit Mnemonic	Description
7	-	**Reserved** The value read from this bit is indeterminate. Do not set this bit.
6	-	**Reserved** The value read from this bit is indeterminate. Do not set this bit.
5	-	**Reserved** The value read from this bit is indeterminate. Do not set this bit.
4	-	**Reserved** The value read from this bit is indeterminate. Do not set this bit.
3	-	**Reserved** The value read from this bit is indeterminate. Do not set this bit.
2	SPIH	**SPI interrupt Priority High bit** SPIHSPILPriority Level 0 0Lowest 0 1 1 0 1 1Highest
1	-	**Reserved** The value read from this bit is indeterminate. Do not set this bit.
0	KBDH	**Keyboard interrupt Priority High bit** KB DHKBDLPriority Level 0 0 Lowest 0 1 1 0 1 1Highest

Reset Value = XXXX X000b

Not bit addressable

23. EEPROM Data Memory

This feature is available only for the AT89C51ED2 device.

The 2K bytes on-chip EEPROM memory block is located at addresses 0000h to 07FFh of the XRAM/ERAM memory space and is selected by setting control bits in the EECON register.

A read or write access to the EEPROM memory is done with a MOVX instruction.

23.1 Write Data

Data is written by byte to the EEPROM memory block as for an external RAM memory.

The following procedure is used to write to the EEPROM memory:

- Check EEBUSY flag
- If the user application interrupts routines use XRAM memory space: Save and disable interrupts.
- Load DPTR with the address to write
- Store A register with the data to be written
- Set bit EEE of EECON register
- Execute a MOVX @DPTR, A
- Clear bit EEE of EECON register
- Restore interrupts.
- EEBUSY flag in EECON is then set by hardware to indicate that programming is in progress and that the EEPROM segment is not available for reading or writing.
- The end of programming is indicated by a hardware clear of the EEBUSY flag.

Figure 23-1 represents the optimal write sequence to the on-chip EEPROM data memory.

24.10 API Call Description

The IAP allows to reprogram a microcontroller on-chip Flash memory without removing it from the system and while the embedded application is running.

The user application can call some Application Programming Interface (API) routines allowing IAP. These API are executed by the bootloader.

To call the corresponding API, the user must use a set of Flash_api routines which can be linked with the application.

Example of Flash_api routines are available on the Atmel web site on the software application note:

C Flash Drivers for the AT89C51RD2/ED2

The API calls description and arguments are shown in Table 24-10.

24.10.1 Process

The application selects an API by setting R1, ACC, DPTR0 and DPTR1 registers.

All calls are made through a common interface “USER_CALL” at the address FFF0h.

The jump at the USER_CALL must be done by LCALL instruction to be able to comeback in the application.

Before jump at the USER_CALL, the bit ENBOOT in AUXR1 register must be set.

24.10.2 Constraints

The interrupts are not disabled by the bootloader.

Interrupts must be disabled by user prior to jump to the USER_CALL, then re-enabled when returning.

Interrupts must also be disabled before accessing EEPROM Data then re-enabled after.

The user must take care of hardware watchdog before launching a Flash operation.

Table 24-10. API Call Summary

Command	R1	A	DPTR0	DPTR1	Returned Value	Command Effect
READ MANUF ID	00h	XXh	0000h	XXh	ACC = Manufacturer Id	Read Manufacturer identifier
READ DEVICE ID1	00h	XXh	0001h	XXh	ACC = Device Id 1	Read Device identifier 1
READ DEVICE ID2	00h	XXh	0002h	XXh	ACC = Device Id 2	Read Device identifier 2
READ DEVICE ID3	00h	XXh	0003h	XXh	ACC = Device Id 3	Read Device identifier 3
ERASE BLOCK	01h	XXh	DPH = 00h	00h	ACC = DPH	Erase block 0
			DPH = 20h			Erase block 1
			DPH = 40h			Erase block 2
			DPH = 80h			Erase block 3
			DPH = C0h			Erase block 4
PROGRAM DATA BYTE	02h	Vaue to write	Address of byte to program	XXh	ACC = 0: DONE	Program up one data byte in the on-chip flash memory.

25. Electrical Characteristics

25.1 Absolute Maximum Ratings

I = industrial	-40°C to 85°C
Storage Temperature	-65°C to + 150°C
Voltage on V_{CC} to V_{SS}	-0.5V to + 6.5V
VVoltage on Any Pin to V_{SS}	-0.5V to V_{CC} + 0.5V
Power Dissipation	1 W[2]

Note: Stresses at or above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions may affect device reliability.
Power dissipation is based on the maximum allowable die temperature and the thermal resistance of the package.

25.2 DC Parameters for Standard Voltage

T_A = -40°C to +85°C; V_{SS} = 0V;

V_{CC} =2.7V to 5.5V and F = 0 to 40 MHz (both internal and external code execution)

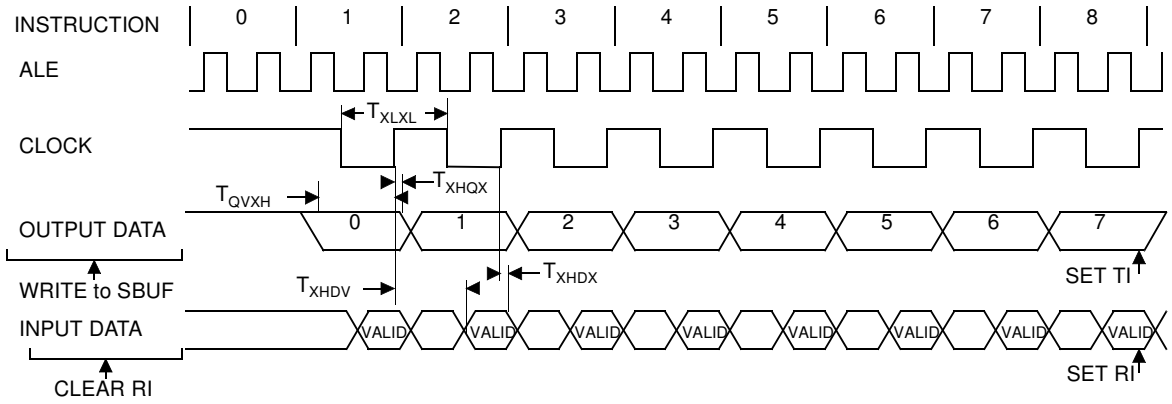
V_{CC} =4.5V to 5.5V and F = 0 to 60 MHz (internal code execution only)

Symbol	Parameter	Min	Typ	Max	Unit	Test Conditions
V_{IL}	Input Low Voltage	-0.5		0.2 V_{CC} - 0.1	V	
V_{IH}	Input High Voltage except RST, XTAL1	0.2 V_{CC} + 0.9		V_{CC} + 0.5	V	
V_{IH1}	Input High Voltage RST, XTAL1	0.7 V_{CC}		V_{CC} + 0.5	V	
V_{OL}	Output Low Voltage, ports 1, 2, 3, 4 [6]			0.3 0.45 1.0	V V V	V_{CC} = 4.5V to 5.5V I_{OL} = 100 µA[4] I_{OL} = 1.6 mA[4] I_{OL} = 3.5 mA[4]
				0.45	V	V_{CC} = 2.7V to 5.5V I_{OL} = 0.8 mA[4]
V_{OL1}	Output Low Voltage, port 0, ALE, $\overline{PSEN}$ [6]			0.3 0.45 1.0	V V V	V_{CC} = 4.5V to 5.5V I_{OL} = 200 µA[4] I_{OL} = 3.2 mA[4] I_{OL} = 7.0 mA[4]
				0.45	V	V_{CC} = 2.7V to 5.5V I_{OL} = 1.6 mA[4]
V_{OH}	Output High Voltage, ports 1, 2, 3, 4	V_{CC} - 0.3 V_{CC} - 0.7 V_{CC} - 1.5			V V V	V_{CC} = 5V ± 10% I_{OH} = -10 µA I_{OH} = -30 µA I_{OH} = -60 µA
		0.9 V_{CC}			V	V_{CC} = 2.7V to 5.5V I_{OH} = -10 µA

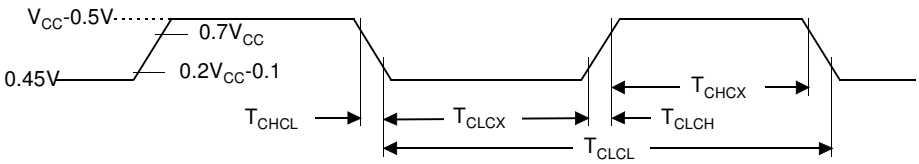
Table 25-9. AC Parameters for a Variable Clock

Symbol	Type	Standard Clock	X2 Clock	X Parameter For -M Range	Units
T_{XLXL}	Min	12 T	6 T		ns
T_{QVHX}	Min	10 T - x	5 T - x	50	ns
T_{XHQX}	Min	2 T - x	T - x	20	ns
T_{XHDX}	Min	x	x	0	ns
T_{XHDV}	Max	10 T - x	5 T- x	133	ns

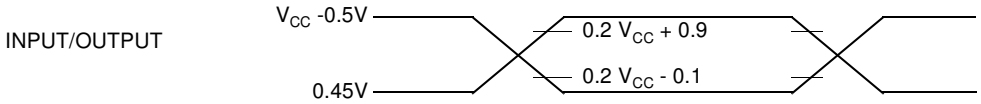
25.3.8 Shift Register Timing Waveforms



25.3.9 External Clock Drive Waveforms

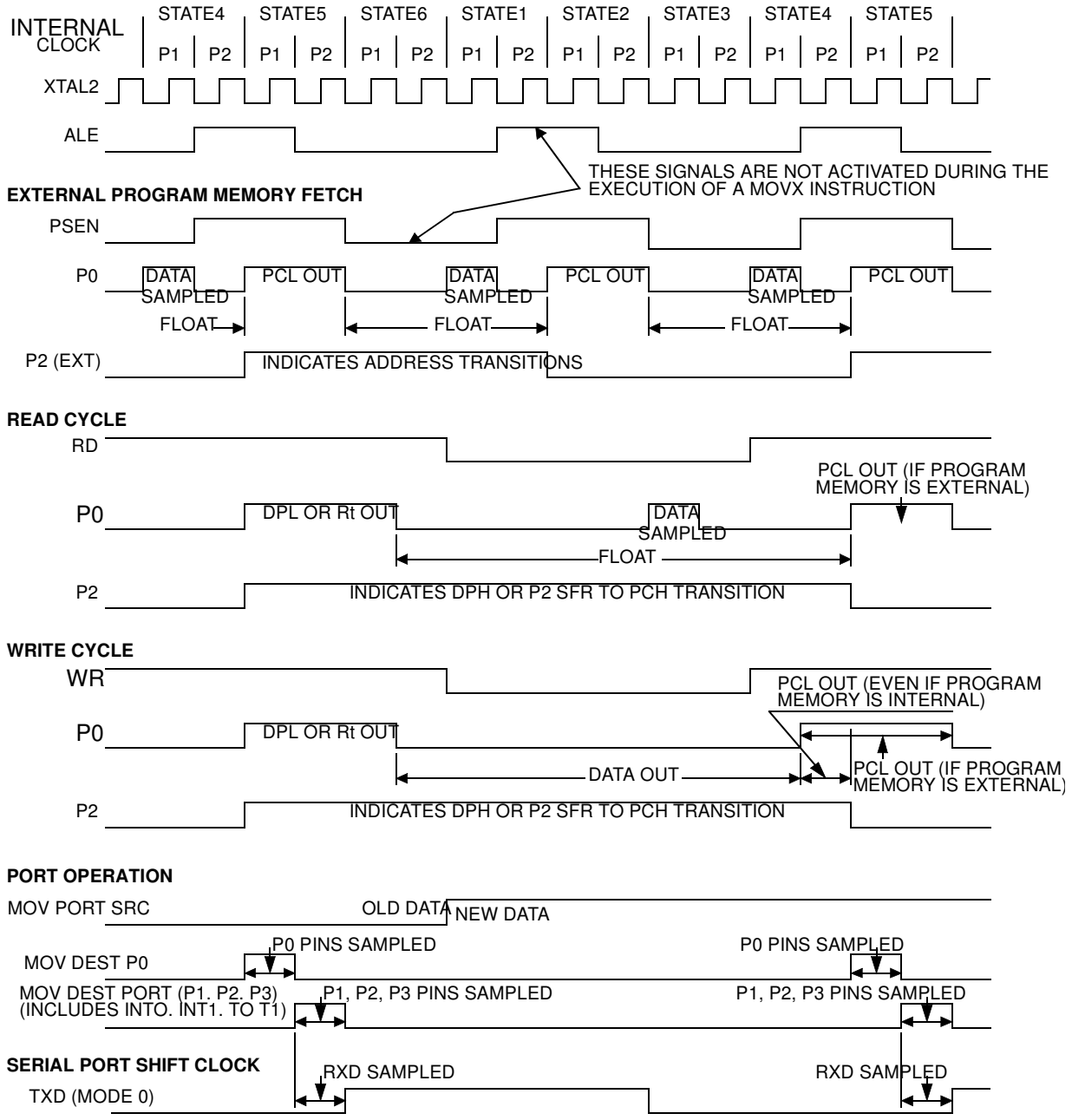


25.3.10 AC Testing Input/Output Waveforms



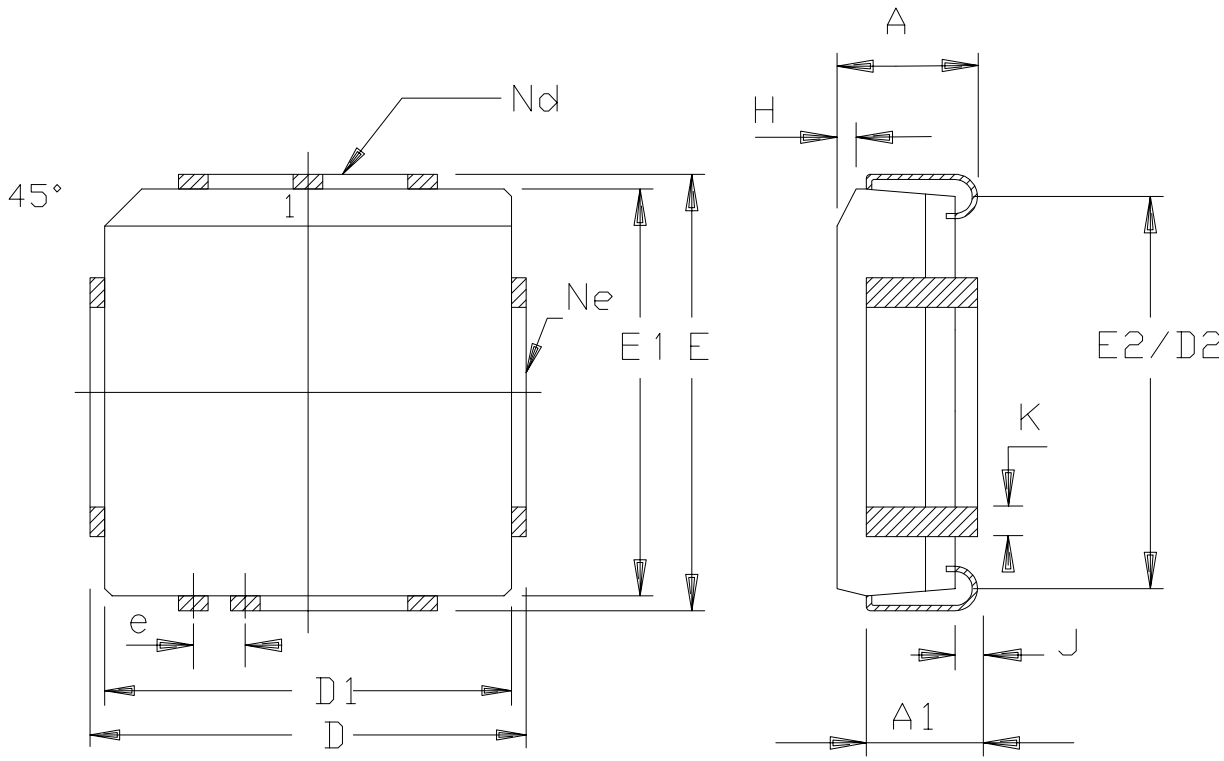
AC inputs during testing are driven at V_{CC} - 0.5 for a logic “1” and 0.45V for a logic “0”. Timing measurement are made at V_{IH} min for a logic “1” and V_{IL} max for a logic “0”.

Figure 25-5. Internal Clock Signals



This diagram indicates when signals are clocked internally. The time it takes the signals to propagate to the pins, however, ranges from 25 to 125 ns. This propagation delay is dependent on variables such as temperature and pin loading. Propagation also varies from output to output and component. Typically though (T_A = 25°C fully loaded) $\overline{RD}$ and $\overline{WR}$ propagation delays are approximately 50 ns. The other signals are typically 85 ns. Propagation delays are incorporated in the AC specifications.

27.3 PLCC68



	MM		INCH	
A	4.20	5.08	.165	.200
A1	2.29	3.30	.090	.130
D	25.02	25.27	.985	.995
D1	24.13	24.33	.950	.958
D2	22.61	23.62	.890	.930
E	25.02	25.27	.985	.995
E1	24.13	24.33	.950	.958
E2	22.61	23.62	.890	.930
e	1.27	BSC	.050	BSC
H	1.07	1.42	.042	.056
J	0.51	-	.020	-
K	0.33	0.53	.013	.021
Nd	17		17	
Ne	17		17	
PKG STD	00			